



# TLC555 LinCMOS™ Timer

## 1 Features

- Very Low Power Consumption:
  - 1 mW Typical at  $V_{DD} = 5\text{ V}$
- Capable of Operation in Astable Mode
- CMOS Output Capable of Swinging Rail to Rail
- High Output Current Capability
  - Sink: 100 mA Typical
  - Source: 10 mA Typical
- Output Fully Compatible With CMOS, TTL, and MOS
- Low Supply Current Reduces Spikes During Output Transitions
- Single-Supply Operation From 2 V to 15 V
- Functionally Interchangeable With the NE555; Has Same Pinout
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015.2
- Available in Q-Temp Automotive
  - High-Reliability Automotive Applications
  - Configuration Control and Print Support
  - Qualification to Automotive Standards

## 2 Applications

- Precision Timing
- Pulse Generation
- Sequential Timing
- Time Delay Generation
- Pulse Width Modulation
- Pulse Position Modulation
- Linear Ramp Generator

## 3 Description

The TLC555 is a monolithic timing circuit fabricated using the TI LinCMOS™ process. The timer is fully compatible with CMOS, TTL, and MOS logic, and operates at frequencies up to 2 MHz. Because of its high input impedance, this device uses smaller timing capacitors than those used by the NE555. As a result, more accurate time delays and oscillations are possible. Power consumption is low across the full range of power-supply voltage.

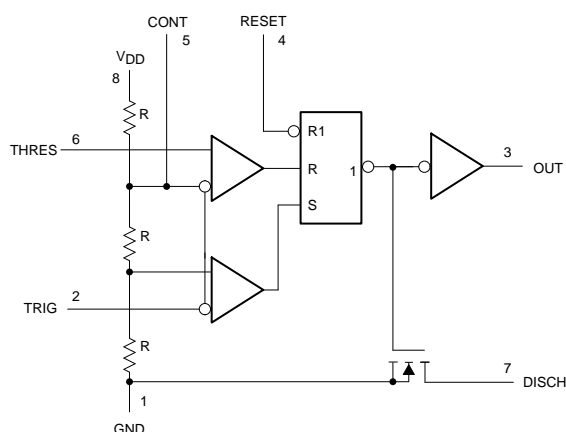
Like the NE555, the TLC555 has a trigger level equal to approximately one-third of the supply voltage and a threshold level equal to approximately two-thirds of the supply voltage. These levels can be altered by use of the control voltage terminal (CONT). When the trigger input (TRIG) falls below the trigger level, the flip-flop is set and the output goes high. If TRIG is above the trigger level and the threshold input (THRES) is above the threshold level, the flip-flop is reset and the output is low. The reset input (RESET) can override all other inputs and can be used to initiate a new timing cycle. If RESET is low, the flip-flop is reset and the output is low. Whenever the output is low, a low-impedance path is provided between the discharge terminal (DISCH) and GND. All unused inputs must be tied to an appropriate logic level to prevent false triggering.

### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TLC555C	SOIC (8)	4.9 mm × 3.91 mm
	PDIP (8)	9.81 mm × 6.38 mm
	SOP (8)	6.20 mm × 5.30 mm
	TSSOP (14)	5.00 mm × 4.40 mm
TLC555I	SOIC (8)	4.90 mm × 3.91 mm
	PDIP (8)	9.81 mm × 6.38 mm
TLC555M	LCCC (20)	8.89 mm × 8.89 mm
	CDIP (8)	9.60 mm × 6.67 mm
TLC555Q	SOIC (8)	4.90 mm × 3.91 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Simplified Schematic



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## 4 Revision History

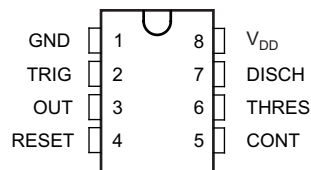
Changes from Revision G (November 2008) to Revision H	Page
• Added <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section .....	<b>1</b>
• Deleted <i>Continuous total power dissipation</i> and <i>lead temperature</i> parameters from <a href="#">Absolute Maximum Ratings</a> .....	<b>6</b>
• Changed values in the <i>Thermal Information</i> table to align with JEDEC standards .....	<b>6</b>
• Deleted <i>Dissipation Ratings</i> table .....	<b>6</b>

## 5 Device Comparison Table

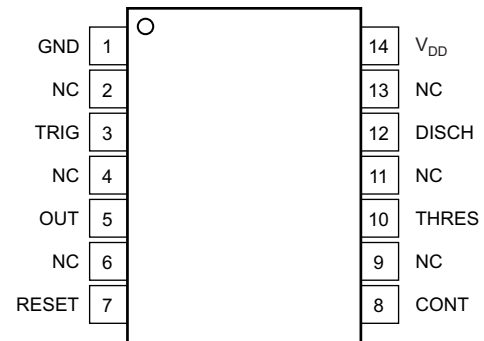
DEVICE	T <sub>A</sub>	V <sub>DD</sub> RANGE	SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)	SSOP (PS)	TSSOP (PW)
TLC555C	0°C to 70°C	2 V to 15 V	✓	—	—	✓	✓	✓
TLC555I	–40°C to 85°C	3 V to 15 V	✓	—	—	✓	—	—
TLC555M	–55°C to 125°C	5 V to 15 V	—	✓	✓	—	—	—
TLC555Q	–40°C to 125°C	5 V to 15 V	✓	—	—	—	—	—

## 6 Pin Configuration and Functions

**TLC555C: D, P, and PS Packages**  
8-Pin SOIC, PDIP, SOP  
Top View



**TLC555C: PW Package**  
14-Pin TSSOP  
Top View



**Pin Functions: TLC555C**

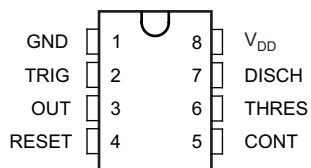
NAME	PIN		I/O	DESCRIPTION
	SOIC, PDIP, SOP	TSSOP		
CONT	5	8	I	Controls comparator thresholds. Outputs 2/3 V <sub>DD</sub> and allows bypass capacitor connection.
DISCH	7	12	O	Open collector output to discharge timing capacitor
GND	1	1		Ground
NC	—	2, 4, 6, 9, 11, 13	—	No internal connection
OUT	3	5	O	High current timer output signal
RESET	4	7	I	Active low reset input forces output and discharge low
THRES	6	10	I	End of timing input. THRES > CONT sets output low and discharge low.
TRIG	2	3	I	Start of timing input. TRIG < ½ CONT sets output high and discharge open.
V <sub>DD</sub>	8	14	—	Power-supply voltage

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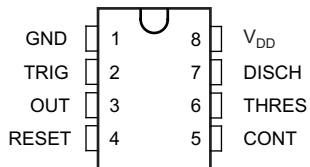
## TLC555I: D and P Packages 8-Pin SOIC, PDIP Top View



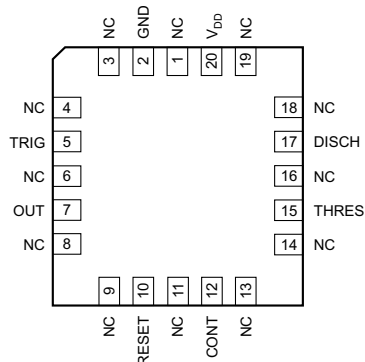
## Pin Functions: TLC555I

PIN		I/O	DESCRIPTION
NAME	SOIC, PDIP		
CONT	5	I	Controls comparator thresholds. Outputs 2/3 V <sub>DD</sub> and allows bypass capacitor connection.
DISCH	7	O	Open-collector output to discharge timing capacitor
GND	1	—	Ground
OUT	3	O	High current timer output signal
RESET	4	I	Active low reset input forces output and discharge low
THRES	6	I	End of timing input. THRES > CONT sets output low and discharge low.
TRIG	2	I	Start of timing input. TRIG < ½ CONT sets output high and discharge open.
V <sub>DD</sub>	8	—	Power-supply voltage

**TLC555M: JG Package  
8-Pin CDIP  
Top View**



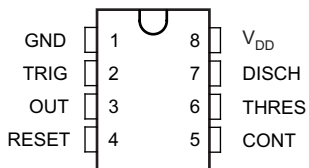
**TLC555M: FK Package  
20-Pin LCCC  
Top View**



**Pin Functions: TLC555M**

NAME	PIN		I/O	DESCRIPTION
	LCCC	CDIP		
CONT	12	5	I	Controls comparator thresholds. Outputs 2/3 V <sub>DD</sub> and allows bypass capacitor connection.
DISCH	17	7	O	Open-collector output to discharge timing capacitor
GND	2	1	—	Ground
NC	1, 3, 4, 6, 8, 9, 11, 13, 14, 16, 18, 19	—	—	No internal connection
OUT	7	3	O	High current timer output signal
RESET	10	4	I	Active low reset input forces output and discharge low
THRES	15	6	I	End of timing input. THRES > CONT sets output low and discharge low.
TRIG	5	2	I	Start of timing input. TRIG < ½ CONT sets output high and discharge open.
V <sub>DD</sub>	20	8	—	Power-supply voltage

**TLC555Q: D Package  
8-Pin SOIC  
Top View**



**Pin Functions: TLC555Q**

NAME	PIN		I/O	DESCRIPTION
	SOIC			
CONT	5		I	Controls comparator thresholds, Outputs 2/3 V <sub>DD</sub> , allows bypass capacitor connection
DISCH	7		O	Open-collector output to discharge timing capacitor
GND	1		—	Ground
OUT	3		O	High current timer output signal
RESET	4		I	Active low reset input forces output and discharge low
THRES	6		I	End of timing input. THRES > CONT sets output low and discharge low
TRIG	2		I	Start of timing input. TRIG < ½ CONT sets output high and discharge open
V <sub>DD</sub>	8		—	Power supply voltage

## TLC555

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## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

			MIN	MAX	UNIT
Voltage	Supply, $V_{DD}$ <sup>(2)</sup>			18	V
	Input, any input		−0.3	$V_{DD}$	V
Current	Sink, discharge or output			150	mA
	Source, output, $I_O$			15	mA
Temperature	Operating, $T_A$	C-suffix	0	70	°C
		I-suffix	−40	85	°C
		Q-suffix	−40	125	°C
		M-suffix	−55	125	°C
	Case, for 60 seconds		−65	150	°C
	Storage, $T_{stg}$		−65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network GND.

### 7.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
Supply voltage, $V_{DD}$			2	15	V
Operating free-air temperature, $T_A$	TLC555C		0	70	°C
	TLC555I		−40	85	°C
	TLC555M		−55	125	°C
	TLC555Q		−40	125	°C

### 7.3 Thermal Information

THERMAL METRIC <sup>(1)</sup>		TLC555						UNIT
		D (SOIC)	FK (LCCC)	JG (CDIP)	P (PDIP)	PS (SOP)	PW (TSSOP)	
		8 PINS	20 PINS	8 PINS	8 PINS	8 PINS	14 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	113	n/a	120	58	120	135	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	58	37	81	48	72	61	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	55	36	110	35	69	77	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	11	n/a	45	26	32	12	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	54	n/a	103	35	68	77	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	n/a	4.3	31	n/a	n/a	n/a	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 7.4 Electrical Characteristics: $V_{DD} = 2\text{ V}$ for TLC555C, $V_{DD} = 3\text{ V}$ for TLC555I

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
V <sub>IT</sub>	Threshold voltage	25°C	TLC555C	0.95	1.33	1.65	V
			TLC555I	1.6	2.4		
		Full range	TLC555C	0.85	1.75	V	
			TLC555I	1.5	2.5		
I <sub>IT</sub>	Threshold current	25°C	TLC555C	10		pA	
			TLC555I	10			
		Max	TLC555C	75		pA	
			TLC555I	150			
V <sub>I(TRIG)</sub>	Trigger voltage	25°C	TLC555C	0.4	0.67	0.95	V
			TLC555I	0.71	1	1.29	
		Full range	TLC555C	0.3	1.05	V	
			TLC555I	0.61	1.39		
I <sub>I(TRIG)</sub>	Trigger current	25°C	TLC555C	10		pA	
			TLC555I	10			
		Max	TLC555C	75		pA	
			TLC555I	150			
V <sub>I(RESET)</sub>	Reset voltage	25°C	TLC555C	0.4	1.1	1.5	V
			TLC555I	0.4	1.1	1.5	
		Full range	TLC555C	0.3	2	V	
			TLC555I	0.3	1.8		
Control voltage (open-circuit) as a percentage of supply voltage		Max	TLC555C	66.7%			
			TLC555I	66.7%			
	Discharge switch on-stage voltage	I <sub>OL</sub> = 1 mA, 25°C	TLC555C	0.03		0.2	V
			TLC555I	0.03		0.2	
		I <sub>OL</sub> = 1 mA, Full range	TLC555C	0.25		V	
			TLC555I	0.375			
	Discharge switch off-stage current	25°C	TLC555C	0.1		nA	
			TLC555I	0.1			
		Max	TLC555C	0.5		nA	
			TLC555I	120			
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> = −300 μA, 25°C	TLC555C	1.5	1.9	V	
			TLC555I	2.5	2.85		
		I <sub>OH</sub> = −300 μA, Full range	TLC555C	1.5		V	
			TLC555I	2.5			
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 1 mA, 25°C	TLC555C	0.07		0.3	V
			TLC555I	0.07		0.3	
		I <sub>OL</sub> = 1 mA, Full range	TLC555C	0.35		V	
			TLC555I	0.4			
I <sub>DD</sub>	Supply current <sup>(2)</sup>	25°C	TLC555C	250		μA	
			TLC555I	250			
		Full range	TLC555C	400		μA	
			TLC555I	500			

(1) Full range is 0°C to 70°C for the TLC555C, and –40°C to 85°C for the TLC555I. For conditions shown as **Max**, use the appropriate value specified in the [Recommended Operating Conditions](#) table.

(2) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or to TRIG.

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**7.5 Electrical Characteristics:  $V_{DD} = 5\text{ V}$** 

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
V <sub>IT</sub>	Threshold voltage	25°C	TLC555C	2.8	3.3	3.8	V
			TLC555I	2.8	3.3	3.8	
			TLC555M	2.8	3.3	3.8	
			TLC555Q	2.8	3.3	3.8	
	Full range	TLC555C	2.7		3.9	V	
		TLC555I	2.7		3.9		
		TLC555M	2.7		3.9		
		TLC555Q	2.7		3.9		
I <sub>IT</sub>	Threshold current	25°C	TLC555C		10	pA	
			TLC555I		10		
			TLC555M		10		
			TLC555Q		10		
	Max	TLC555C		75	pA		
		TLC555I		150			
		TLC555M		5000			
		TLC555Q		5000			
V <sub>I(TRIG)</sub>	Trigger voltage	25°C	TLC555C	1.36	1.66	1.96	V
			TLC555I	1.36	1.66	1.96	
			TLC555M	1.36	1.66	1.96	
			TLC555Q	1.36	1.66	1.96	
	Full range	TLC555C	1.26		2.06	V	
		TLC555I	1.26		2.06		
		TLC555M	1.26		2.06		
		TLC555Q	1.26		2.06		
I <sub>I(TRIG)</sub>	Trigger current	25°C	TLC555C		10	pA	
			TLC555I		10		
			TLC555M		10		
			TLC555Q		10		
	Max	TLC555C		75	pA		
		TLC555I		150			
		TLC555M		5000			
		TLC555Q		5000			
V <sub>I(RESET)</sub>	Reset voltage	25°C	TLC555C	0.4	1.1	1.5	V
			TLC555I	0.4	1.1	1.5	
			TLC555M	0.4	1.1	1.5	
			TLC555Q	0.4	1.1	1.5	
	Full range	TLC555C	0.3		1.8	V	
		TLC555I	0.3		1.8		
		TLC555M	0.3		1.8		
		TLC555Q	0.3		1.8		
I <sub>I(RESET)</sub>	Reset current	25°C	TLC555C		10	pA	
			TLC555I		10		
			TLC555M		10		
			TLC555Q		10		
	Max	TLC555C		75	pA		
		TLC555I		150			
		TLC555M		5000			
		TLC555Q		5000			

(1) Full range is 0°C to 70°C the for TLC555C, –40°C to 85°C for the TLC555I, –40°C to 125°C for the TLC555Q, and –55°C to 125°C for the TLC555M. For conditions shown as **Max**, use the appropriate value specified in the [Recommended Operating Conditions](#) table.



**Electrical Characteristics:  $V_{DD} = 5\text{ V}$  (continued)**

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
Control voltage (open circuit) as a percentage of supply voltage	Max	TLC555C		66.7%		
		TLC555I		66.7%		
		TLC555M		66.7%		
		TLC555Q		66.7%		
Discharge switch on-stage voltage	$I_{OL} = 10\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C		0.14	0.5	V
		TLC555I		0.14	0.5	
		TLC555M		0.14	0.5	
		TLC555Q		0.14	0.5	
	$I_{OL} = 10\text{ mA}$ , Full range	TLC555C			0.6	V
		TLC555I			0.6	
		TLC555M			0.6	
		TLC555Q			0.6	
Discharge switch off-stage current	$25^{\circ}\text{C}$	TLC555C		0.1		nA
		TLC555I		0.1		
		TLC555M		0.1		
		TLC555Q		0.1		
	Max	TLC555C		0.5		nA
		TLC555I		120		
		TLC555M		120		
		TLC555Q		120		
$V_{OH}$ High-level output voltage	$I_{OH} = -1\text{ }\mu\text{A}$ , $25^{\circ}\text{C}$	TLC555C	4.1	4.8		V
		TLC555I	4.1	4.8		
		TLC555M	4.1	4.8		
		TLC555Q	4.1	4.8		
	$I_{OH} = -1\text{ }\mu\text{A}$ , Full range	TLC555C	4.1			V
		TLC555I	4.1			
		TLC555M	4.1			
		TLC555Q	4.1			
$V_{OL}$ Low-level output voltage	$I_{OL} = 8\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C		0.21	0.4	V
		TLC555I		0.21	0.4	
		TLC555M		0.21	0.4	
		TLC555Q		0.21	0.4	
	$I_{OL} = 8\text{ mA}$ , Full range	TLC555C			0.5	V
		TLC555I			0.5	
		TLC555M			0.6	
		TLC555Q			0.6	

**TLC555**

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**Electrical Characteristics:  $V_{DD} = 5\text{ V}$  (continued)**

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
$V_{OL}$ Low-level output voltage	$I_{OL} = 5\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C		0.13	0.3	V
		TLC555I		0.13	0.3	
		TLC555M		0.13	0.3	
		TLC555Q		0.13	0.3	
	$I_{OL} = 5\text{ mA}$ , Full range	TLC555C			0.4	V
		TLC555I			0.4	
		TLC555M			0.45	
		TLC555Q			0.45	
	$I_{OL} = 3.2\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C		0.08	0.3	V
		TLC555I		0.08	0.3	
		TLC555M		0.8	0.3	
		TLC555Q		0.8	0.3	
	$I_{OL} = 3.2\text{ mA}$ , Full range	TLC555C			0.35	V
		TLC555I			0.35	
		TLC555M			0.4	
		TLC555Q			0.4	
$I_{DD}$ Supply current <sup>(2)</sup>	$25^{\circ}\text{C}$	TLC555C		170	350	$\mu\text{A}$
		TLC555I		170	350	
		TLC555M		170	350	
		TLC555Q		170	350	
	Full range	TLC555C			500	$\mu\text{A}$
		TLC555I			600	
		TLC555M			700	
		TLC555Q			700	

(2) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or to TRIG.

## 7.6 Electrical Characteristics: $V_{DD} = 15\text{ V}$

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
V <sub>IT</sub>	Threshold voltage	25°C	TLC555C	9.45	10	10.55	V
			TLC555I	9.45	10	10.55	
			TLC555M	9.45	10	10.55	
			TLC555Q	9.45	10	10.55	
	Full range	TLC555C	9.35		10.65	V	
		TLC555I	9.35		10.65		
		TLC555M	9.35		10.65		
		TLC555Q	9.35		10.65		
I <sub>IT</sub>	Threshold current	25°C	TLC555C		10	pA	
			TLC555I		10		
			TLC555M		10		
			TLC555Q		10		
	Max	TLC555C		75	pA		
		TLC555I		150			
		TLC555M		5000			
		TLC555Q		5000			
V <sub>I(TRIG)</sub>	Trigger voltage	25°C	TLC555C	4.65	5	5.35	V
			TLC555I	4.65	5	5.35	
			TLC555M	4.65	5	5.35	
			TLC555Q	4.65	5	5.35	
	Full range	TLC555C	4.55		5.45	V	
		TLC555I	4.55		5.45		
		TLC555M	4.55		5.45		
		TLC555Q	4.55		5.45		
I <sub>I(TRIG)</sub>	Trigger current	25°C	TLC555C		10	pA	
			TLC555I		10		
			TLC555M		10		
			TLC555Q		10		
	Max	TLC555C		75	pA		
		TLC555I		150			
		TLC555M		5000			
		TLC555Q		5000			
V <sub>I(RESET)</sub>	Reset voltage	25°C	TLC555C	0.4	1.1	1.5	V
			TLC555I	0.4	1.1	1.5	
			TLC555M	0.4	1.1	1.5	
			TLC555Q	0.4	1.1	1.5	
	Full range	TLC555C	0.3		1.8	V	
		TLC555I	0.3		1.8		
		TLC555M	0.3		1.8		
		TLC555Q	0.3		1.8		
I <sub>I(RESET)</sub>	Reset current	25°C	TLC555C		10	pA	
			TLC555I		10		
			TLC555M		10		
			TLC555Q		10		
	Max	TLC555C		75	pA		
		TLC555I		150			
		TLC555M		5000			
		TLC555Q		5000			

(1) Full range is 0°C to 70°C for TLC555C, –40°C to 85°C for TLC555I, –40°C to 125°C for the TLC555Q, and –55°C to 125°C for TLC555M. For conditions shown as **Max**, use the appropriate value specified in the [Recommended Operating Conditions](#) table.

**TLC555**

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**Electrical Characteristics:  $V_{DD} = 15\text{ V}$  (continued)**

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
Control voltage (open circuit) as a percentage of supply voltage	Max	TLC555C		66.7%		
		TLC555I		66.7%		
		TLC555M		66.7%		
		TLC555Q		66.7%		
Discharge switch on-stage voltage	$I_{OL} = 100\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C		0.77	1.7	V
		TLC555I		0.77	1.7	
		TLC555M		0.77	1.7	
		TLC555Q		0.77	1.7	
	$I_{OL} = 100\text{ mA}$ , Full range	TLC555C			1.8	V
		TLC555I			1.8	
		TLC555M			1.8	
		TLC555Q			1.8	
Discharge switch off-stage current	$25^{\circ}\text{C}$	TLC555C		0.1		nA
		TLC555I		0.1		
		TLC555M		0.1		
		TLC555Q		0.1		
	Max	TLC555C		0.5		nA
		TLC555I		120		
		TLC555M		120		
		TLC555Q		120		
$V_{OH}$ High-level output voltage	$I_{OH} = -10\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C	12.5	14.2		V
		TLC555I	12.5	14.2		
		TLC555M	12.5	14.2		
		TLC555Q	12.5	14.2		
	$I_{OH} = -10\text{ mA}$ , Full range	TLC555C	12.5			V
		TLC555I	12.5			
		TLC555M	12.5			
		TLC555Q	12.5			
	$I_{OH} = -5\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C	13.5	14.6		V
		TLC555I	13.5	14.6		
		TLC555M	13.5	14.6		
		TLC555Q	13.5	14.6		
	$I_{OH} = -5\text{ mA}$ , Full range	TLC555C	13.5			V
		TLC555I	13.5			
		TLC555M	13.5			
		TLC555Q	13.5			
	$I_{OH} = -1\text{ mA}$ , $25^{\circ}\text{C}$	TLC555C	14.2	14.9		V
		TLC555I	14.2	14.9		
		TLC555M	14.2	14.9		
		TLC555Q	14.2	14.9		
	$I_{OH} = -1\text{ mA}$ , Full range	TLC555C	14.2			V
		TLC555I	14.2			
		TLC555M	14.2			
		TLC555Q	14.2			

**Electrical Characteristics:  $V_{DD} = 15\text{ V}$  (continued)**

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>(1)</sup>		MIN	TYP	MAX	UNIT
$V_{OL}$ Low-level output voltage	$I_{OL} = 100\text{ mA}$ , $25^\circ\text{C}$	TLC555C		1.28	3.2	V
		TLC555I		1.28	3.2	
		TLC555M		1.28	3.2	
		TLC555Q		1.28	3.2	
	$I_{OL} = 100\text{ mA}$ , Full range	TLC555C			3.6	V
		TLC555I			3.7	
		TLC555M			3.8	
		TLC555Q			3.8	
	$I_{OL} = 50\text{ mA}$ , $25^\circ\text{C}$	TLC555C		0.63	1	V
		TLC555I		0.63	1	
		TLC555M		0.63	1	
		TLC555Q		0.63	1	
	$I_{OL} = 50\text{ mA}$ , Full range	TLC555C			1.3	V
		TLC555I			1.4	
		TLC555M			1.5	
		TLC555Q			1.5	
	$I_{OL} = 10\text{ mA}$ , $25^\circ\text{C}$	TLC555C		0.12	0.3	V
		TLC555I		0.12	0.3	
		TLC555M		0.12	0.3	
		TLC555Q		0.12	0.3	
	$I_{OL} = 10\text{ mA}$ , Full range	TLC555C			0.4	V
		TLC555I			0.4	
		TLC555M			0.45	
		TLC555Q			0.45	
$I_{DD}$ Supply current <sup>(2)</sup>	$25^\circ\text{C}$	TLC555C		360	600	$\mu\text{A}$
		TLC555I		360	600	
		TLC555M		360	600	
		TLC555Q		360	600	
	Full range	TLC555C			800	$\mu\text{A}$
		TLC555I			900	
		TLC555M			1000	
		TLC555Q			1000	

(2) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

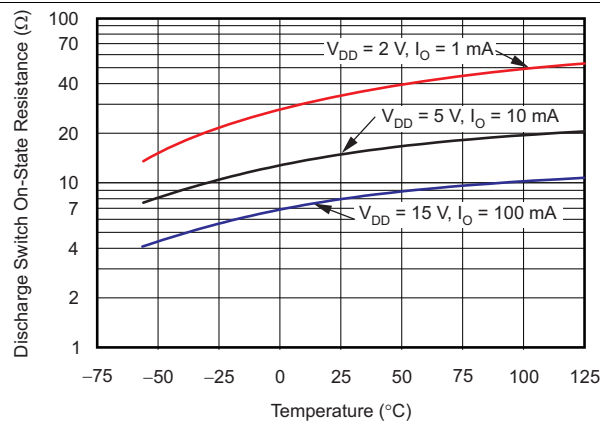
## 7.7 Electrical Characteristics: $V_{DD} = 5\text{ V}$

At  $T_A = 25^\circ\text{C}$ , over operating free-air temperature range (unless otherwise noted)

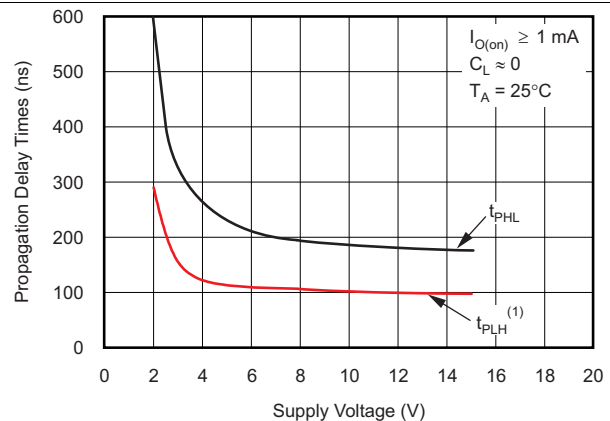
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{IT}$	Threshold voltage	2.8	3.3	3.8	V
$I_{IT}$	Threshold current		10		pA
$V_{I(TRIG)}$	Trigger voltage	1.36	1.66	1.96	V
$I_{I(TRIG)}$	Trigger current		10		pA
$V_{I(RESET)}$	Reset voltage	0.4	1.1	1.5	V
$I_{I(RESET)}$	Reset current		10		pA
	Control voltage (open circuit) as a percentage of supply voltage		66.7%		
	Discharge switch on-stage voltage	$I_{OL} = 10\text{ mA}$	0.14	0.5	v
	Discharge switch off-stage current		0.1		nA
$V_{OH}$	High-level output voltage	$I_{OH} = -1\text{ mA}$	4.1	4.8	V
$V_{OL}$	Low-level output voltage	$I_{OL} = 8\text{ mA}$	0.21	0.4	V
		$I_{OL} = 5\text{ mA}$	0.13	0.3	V
		$I_{OL} = 3.2\text{ mA}$	0.08	0.3	V
$I_{DD}$	Supply current <sup>(1)</sup>		170	350	$\mu\text{A}$

(1) These values apply for the expected operating configurations in which THRES is connected directly to DISCH or TRIG.

## 7.8 Typical Characteristics



**Figure 1. Discharge Switch ON-State Resistance vs Free-Air Temperature**



(1) The effects of the load resistance on these values must be taken into account separately.

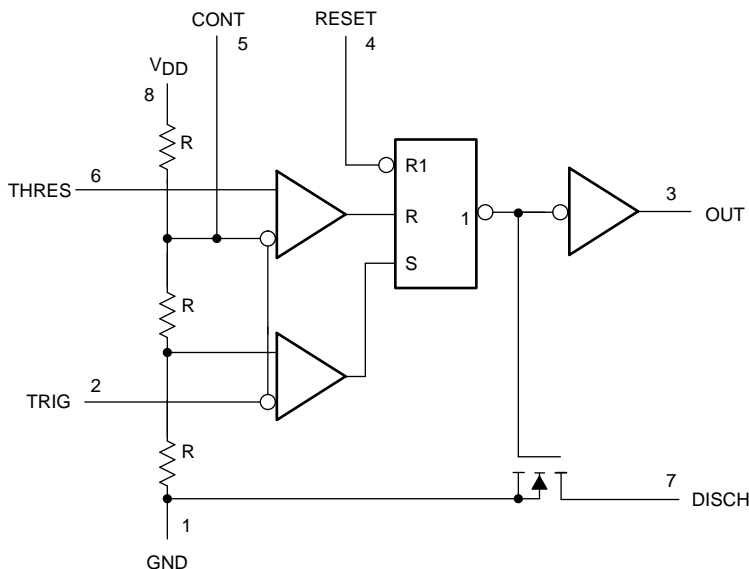
**Figure 2. Propagation Delay Times to Discharge Output from Trigger and Threshold Shorted Together vs Supply Voltage**

## 8 Detailed Description

### 8.1 Overview

The TLC555 is a precision timing device used for general-purpose timing applications up to 2.1 MHz.

### 8.2 Functional Block Diagram



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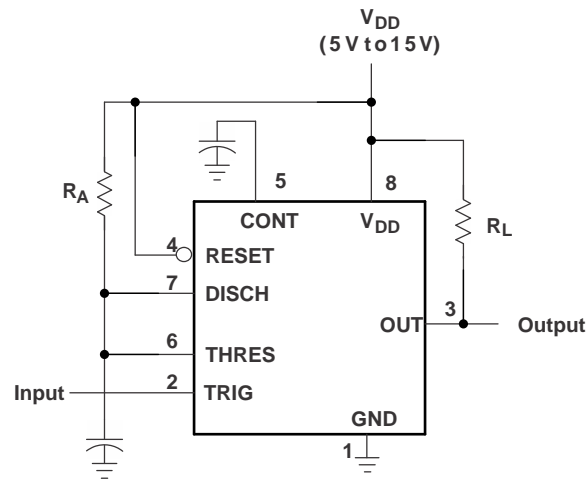
Pin numbers are for all packages except the FK package. RESET can override TRIG, which can override THRES.

### 8.3 Feature Description

#### 8.3.1 Monostable Operation

For monostable operation, any of these timers can be connected as shown in [Figure 3](#). If the output is low, application of a negative-going pulse to the trigger (TRIG) sets the flip-flop ( $\overline{Q}$  goes low), drives the output high, and turns off Q1. Capacitor C then is charged through  $R_A$  until the voltage across the capacitor reaches the threshold voltage of the threshold (THRES) input. If TRIG has returned to a high level, the output of the threshold comparator resets the flip-flop ( $\overline{Q}$  goes high), drives the output low, and discharges C through Q1.

## Feature Description (continued)

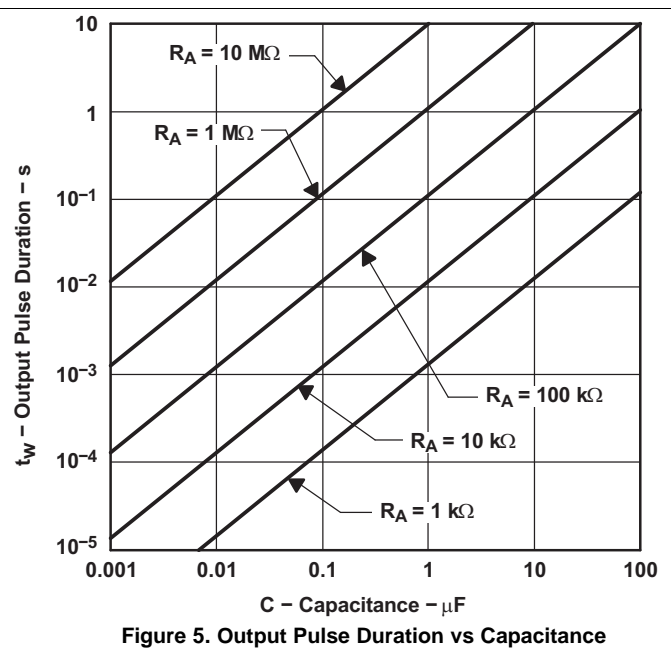
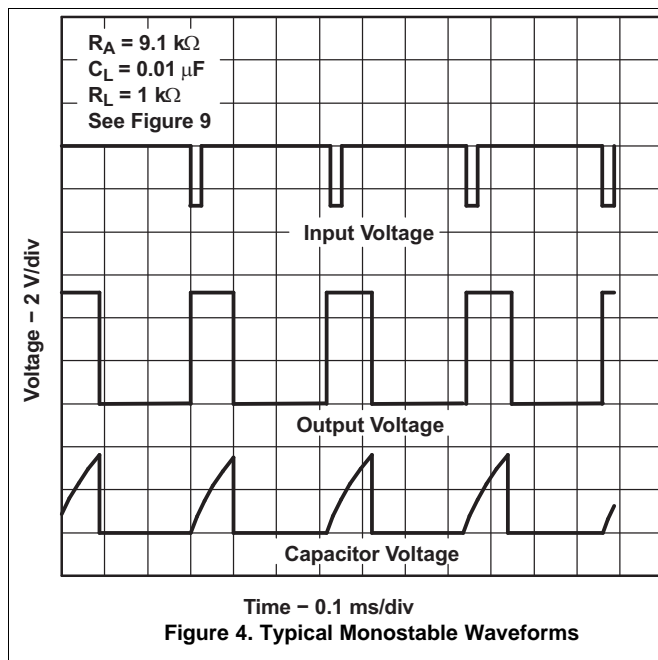


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**Figure 3. Circuit for Monostable Operation**

Monostable operation is initiated when TRIG voltage falls below the trigger threshold. Once initiated, the sequence ends only if TRIG is high for at least 10  $\mu$ s before the end of the timing interval. When the trigger is grounded, the comparator storage time can be as long as 10  $\mu$ s, which limits the minimum monostable pulse width to 10  $\mu$ s. Because of the threshold level and saturation voltage of Q1, the output pulse duration is approximately  $t_w = 1.1R_A C$ . [Figure 4](#) is a plot of the time constant for various values of  $R_A$  and C. The threshold levels and charge rates both are directly proportional to the supply voltage,  $V_{CC}$ . The timing interval is, therefore, independent of the supply voltage, so long as the supply voltage is constant during the time interval.

Applying a negative-going trigger pulse simultaneously to RESET and TRIG during the timing interval discharges C and reinitiates the cycle, commencing on the positive edge of the reset pulse. The output is held low as long as the reset pulse is low. To prevent false triggering, when RESET is not used it must be connected to  $V_{CC}$ .





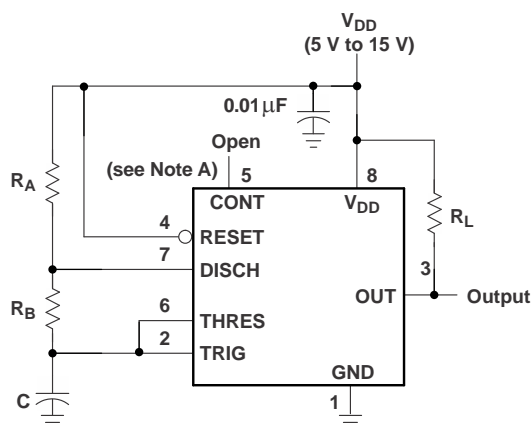
## Feature Description (continued)

### 8.3.2 Astable Operation

As shown in Figure 6, adding a second resistor,  $R_B$ , to the circuit of Figure 3 and connecting the trigger input to the threshold input causes the timer to self-trigger and run as a multi-vibrator. The capacitor  $C$  charges through  $R_A$  and  $R_B$  and then discharges through  $R_B$  only. Therefore, the duty cycle is controlled by the values of  $R_A$  and  $R_B$ .

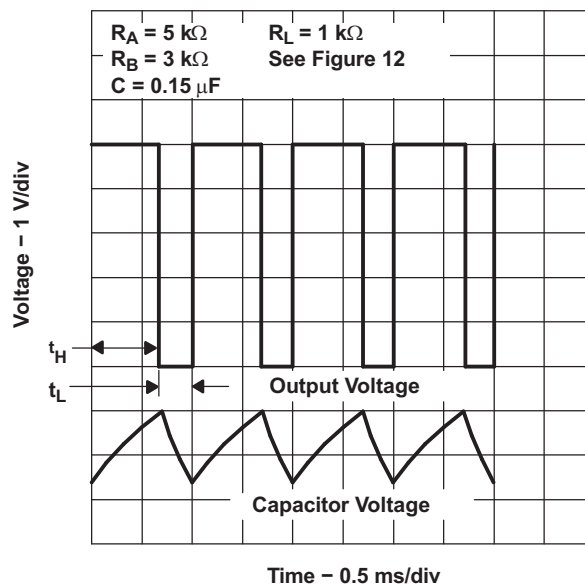
This astable connection results in capacitor  $C$  charging and discharging between the threshold-voltage level ( $\approx 0.67 \times V_{CC}$ ) and the trigger-voltage level ( $\approx 0.33 \times V_{CC}$ ). As in the monostable circuit, charge and discharge times (and, therefore, the frequency and duty cycle) are independent of the supply voltage.

Decoupling CONT voltage to ground with a capacitor can improve operation. This should be evaluated for individual applications.



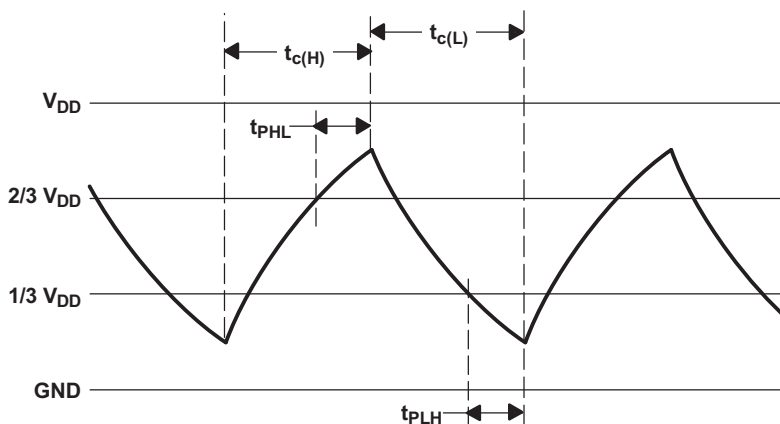
NOTE A: Decoupling CONT voltage to ground with a capacitor can improve operation. This should be evaluated for individual applications.

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**Figure 6. Circuit for Astable Operation**

**Figure 7. Typical Astable Waveforms**



**Figure 8. Trigger and Threshold Voltage Waveform**

Figure 7 shows typical waveforms generated during astable operation. The output high-level duration  $t_H$  and low-level duration  $t_L$  can be calculated as follows:

$$t_H = 0.693(R_A + R_B)C \quad (1)$$

$$t_L = 0.693(R_B)C \quad (2)$$

Other useful relationships are shown below:

$$\text{period} = t_H + t_L = 0.693(R_A + 2R_B)C \quad (3)$$

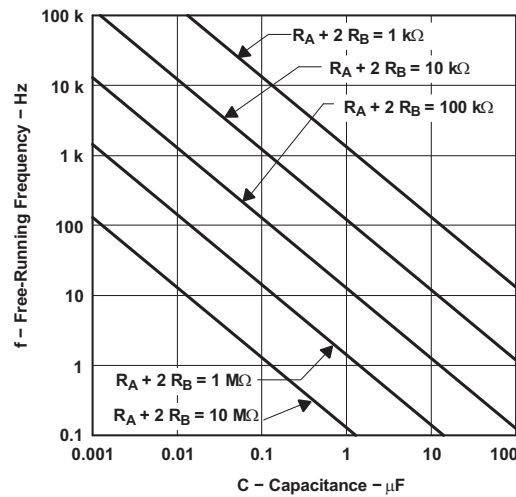
## Feature Description (continued)

$$\text{frequency} \approx \frac{1.44}{(R_A + 2R_B)C} \quad (4)$$

$$\text{Output driver duty cycle} = \frac{t_L}{t_H + t_L} = \frac{R_B}{R_A + 2R_B} \quad (5)$$

$$\text{Output waveform duty cycle} = \frac{t_H}{t_H + t_L} = 1 - \frac{R_B}{R_A + 2R_B} \quad (6)$$

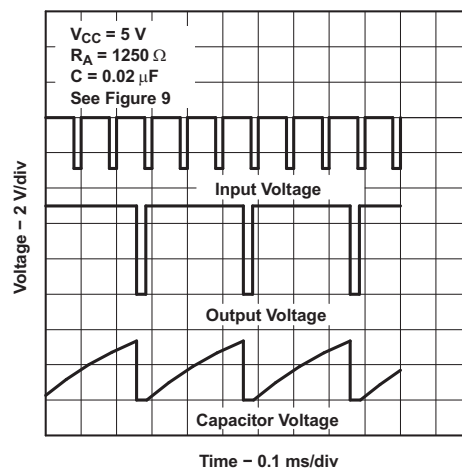
$$\text{Low-to-high ratio} = \frac{t_L}{t_H} = \frac{R_B}{R_A + R_B} \quad (7)$$



**Figure 9. Free-Running Frequency**

### 8.3.3 Frequency Divider

By adjusting the length of the timing cycle, the basic circuit of [Figure 6](#) can be made to operate as a frequency divider. [Figure 10](#) shows a divide-by-three circuit that makes use of the fact that re-triggering cannot occur during the timing cycle.



**Figure 10. Divide-by-Three Circuit Waveforms**

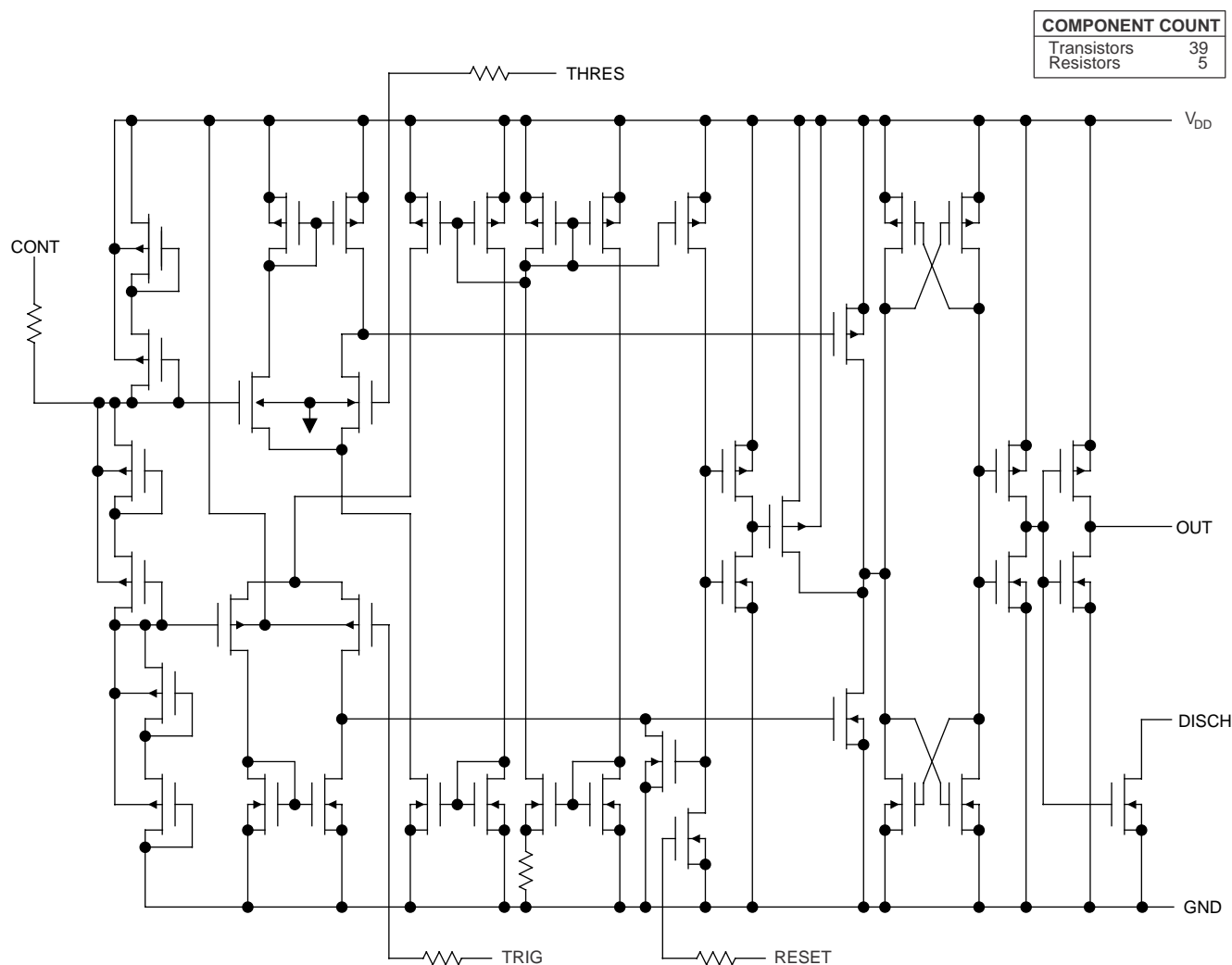
## 8.4 Device Functional Modes

Table 1 shows the device functional modes.

**Table 1. Function Table**

RESET VOLTAGE <sup>(1)</sup>	TRIGGER VOLTAGE <sup>(1)</sup>	THRESHOLD VOLTAGE <sup>(1)</sup>	OUTPUT	DISCHARGE SWITCH
<MIN	Irrelevant	Irrelevant	L	On
>MAX	<MIN	Irrelevant	H	Off
>MAX	>MAX	>MAX	L	On
>MAX	>MAX	<MIN	As previously established	

(1) For conditions shown as MIN or MAX, use the appropriate value specified under *Electrical Characteristics:  $V_{DD} = 5\text{ V}$* .



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**Figure 11. Equivalent Schematic (Each Channel)**

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

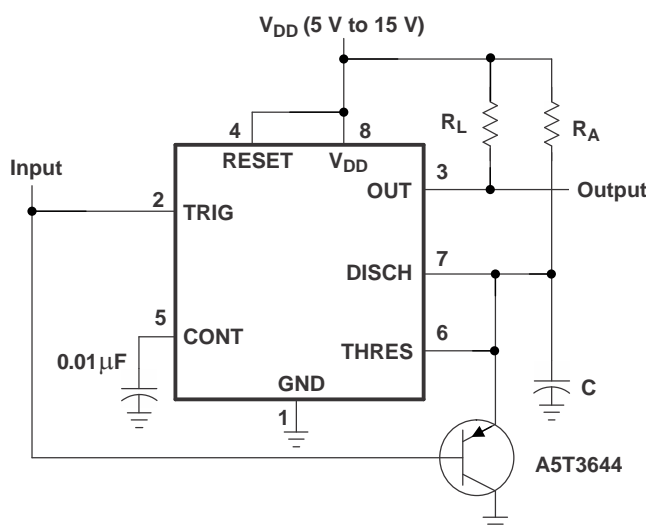
### 9.1 Application Information

The TLC555 timer device uses resistor and capacitor charging delay to provide a programmable time delay or operating frequency. The [Typical Applications](#) section presents a simplified discussion of the design process.

### 9.2 Typical Applications

#### 9.2.1 Missing-Pulse Detector

The circuit shown in [Figure 12](#) can be used to detect a missing pulse or abnormally long spacing between consecutive pulses in a train of pulses. The timing interval of the monostable circuit is re-triggered continuously by the input pulse train as long as the pulse spacing is less than the timing interval. A longer pulse spacing, missing pulse, or terminated pulse train permits the timing interval to be completed, thereby generating an output pulse as shown in [Figure 13](#).



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**Figure 12. Circuit for Missing-Pulse Detector**

##### 9.2.1.1 Design Requirements

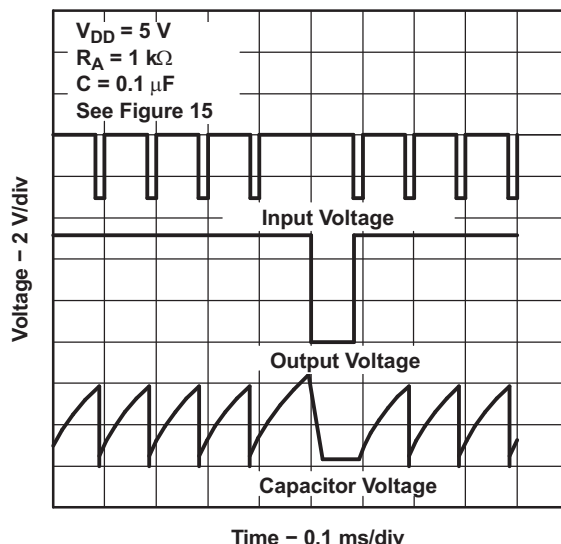
Input fault (missing pulses) must be input high. An input stuck low cannot be detected because the timing capacitor (C) remains discharged.

##### 9.2.1.2 Detailed Design Procedure

Choose  $R_A$  and  $C$  so that  $R_A \times C > [\text{maximum normal input high time}]$ .  $R_L$  improves  $V_{OH}$ , but it is not required for TTL compatibility.

## Typical Applications (continued)

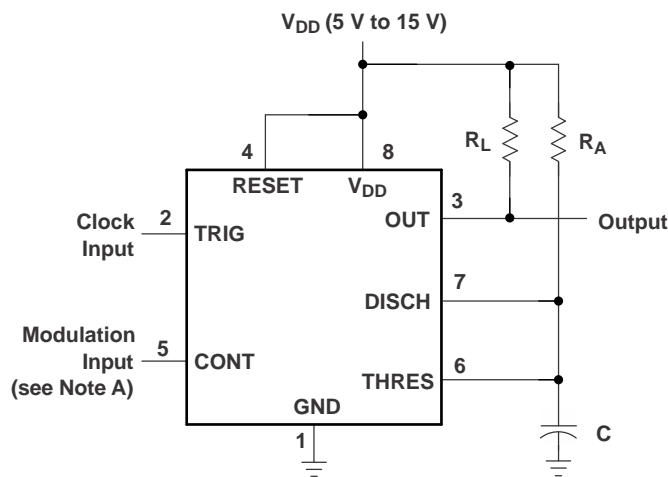
### 9.2.1.3 Application Curve



**Figure 13. Completed Timing Waveforms for Missing-Pulse Detector**

### 9.2.2 Pulse-Width Modulation

The operation of the timer can be modified by modulating the internal threshold and trigger voltages, which is accomplished by applying an external voltage (or current) to CONT. Figure 14 shows a circuit for pulse-width modulation. A continuous input pulse train triggers the monostable circuit, and a control signal modulates the threshold voltage. Figure 15 shows the resulting output pulse-width modulation. While a sine-wave modulation signal is shown, any wave shape could be used.



NOTE A: The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, the effects of modulation source voltage and impedance on the bias of the timer should be considered.

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The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, consider the effects of modulation source voltage and impedance on the bias of the timer.

**Figure 14. Circuit for Pulse-Width Modulation**

## Typical Applications (continued)

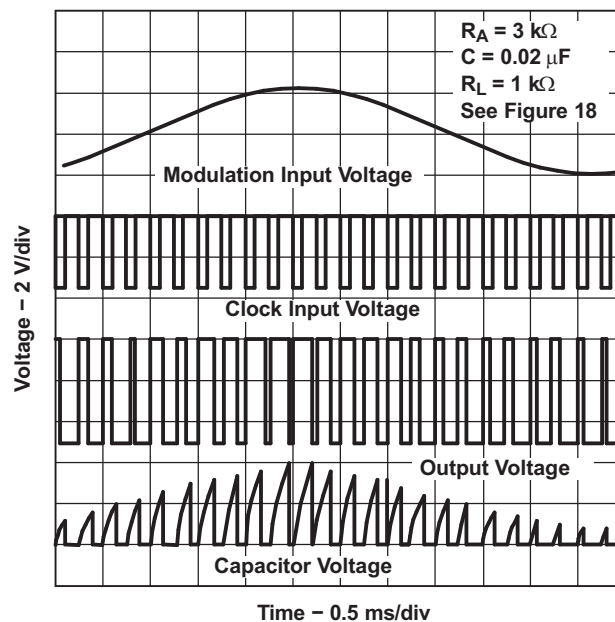
### 9.2.2.1 Design Requirements

The clock input must have  $V_{OL}$  and  $V_{OH}$  levels that are less than and greater than  $1/3 V_{DD}$ , respectively. Modulation input can vary from ground to  $V_{DD}$ . The application must be tolerant of a nonlinear transfer function; the relationship between modulation input and pulse width is not linear because the capacitor charge is RC based with an negative exponential curve.

### 9.2.2.2 Detailed Design Procedure

Choose  $R_A$  and  $C$  so that  $R_A \times C = 1/4$  [clock input period].  $R_L$  improves  $V_{OH}$ , but it is not required for TTL compatibility.

### 9.2.2.3 Application Curve

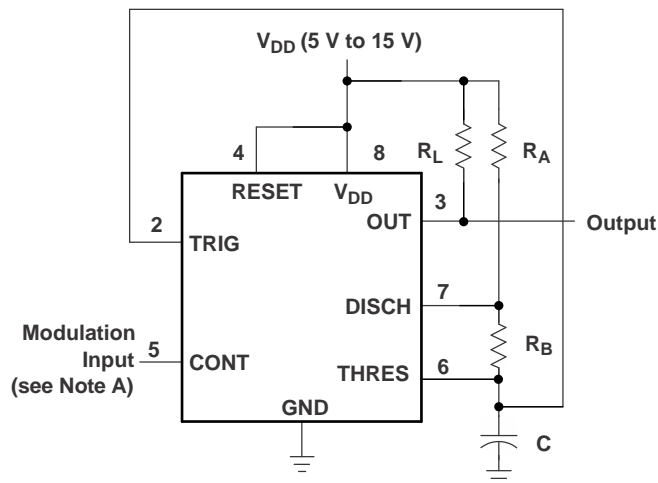


**Figure 15. Pulse-Width-Modulation Waveforms**

### 9.2.3 Pulse-Position Modulation

As shown in [Figure 16](#), any of these timers can be used as a pulse-position modulator. This application modulates the threshold voltage and thereby the time delay of a free-running oscillator. [Figure 17](#) shows a triangular-wave modulation signal for such a circuit; however, any wave shape could be used.

## Typical Applications (continued)



NOTE A: The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, the effects of modulation source voltage and impedance on the bias of the timer should be considered.

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The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, consider the effects of modulation source voltage and impedance on the bias of the timer.

**Figure 16. Circuit for Pulse-Position Modulation**

## Typical Applications (continued)

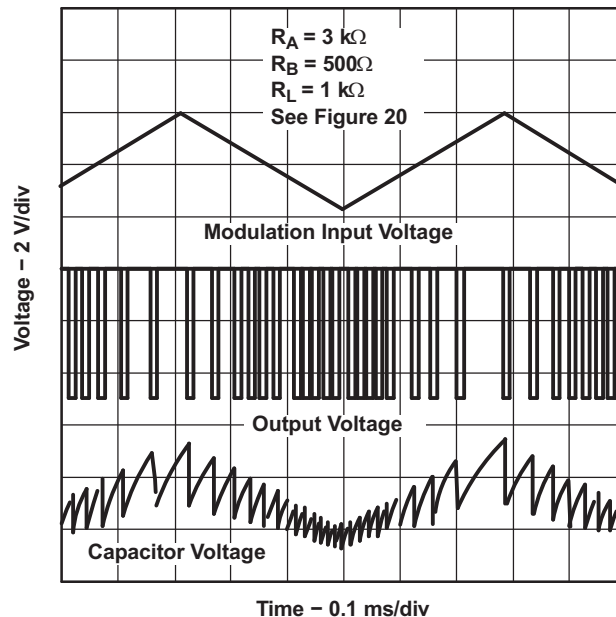
### 9.2.3.1 Design Requirements

Both DC- and AC-coupled modulation input changes the upper and lower voltage thresholds for the timing capacitor. Both frequency and duty cycle vary with the modulation voltage.

### 9.2.3.2 Detailed Design Procedure

The nominal output frequency and duty cycle can be determined using formulas in [Astable Operation](#).  $R_L$  improves  $V_{OH}$ , but it is not required for TTL compatibility.

### 9.2.3.3 Application Curve



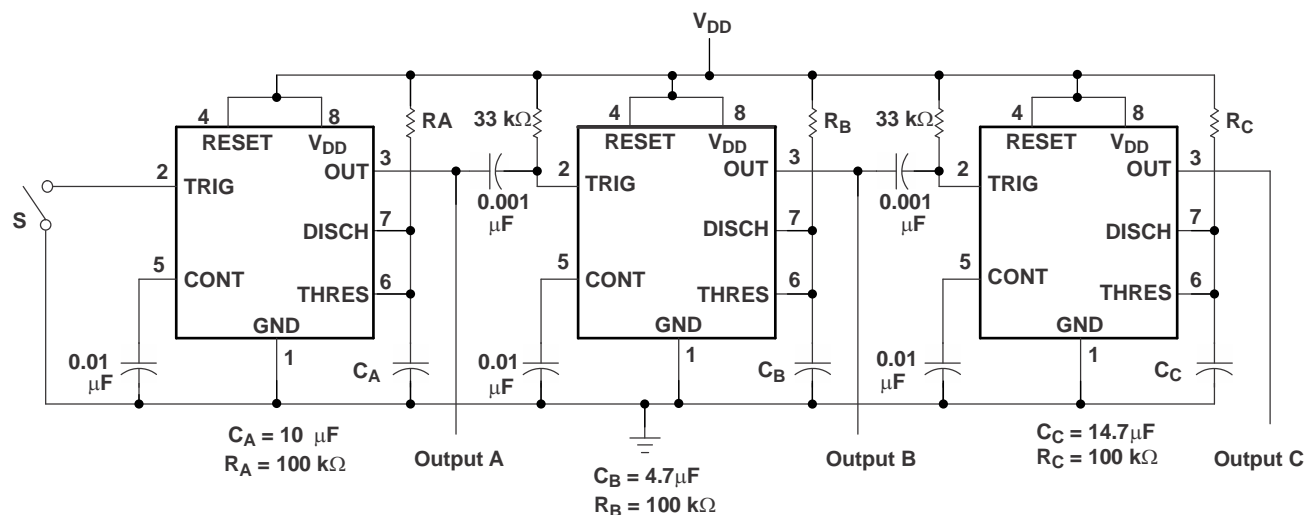
**Figure 17. Pulse-Position-Modulation Waveforms**

### 9.2.4 Sequential Timer

Many applications, such as computers, require signals for initializing conditions during start-up. Other applications, such as test equipment, require activation of test signals in sequence. These timing circuits can be connected to provide such sequential control. The timers can be used in various combinations of astable or monostable circuit connections, with or without modulation, for extremely flexible waveform control. [Figure 18](#) shows a sequencer circuit with possible applications in many systems, and [Figure 19](#) shows the output waveforms.



## Typical Applications (continued)



NOTE A: S closes momentarily at  $t = 0$ .

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S closes momentarily at  $t = 0$ .

Figure 18. Sequential Timer Circuit

### 9.2.4.1 Design Requirements

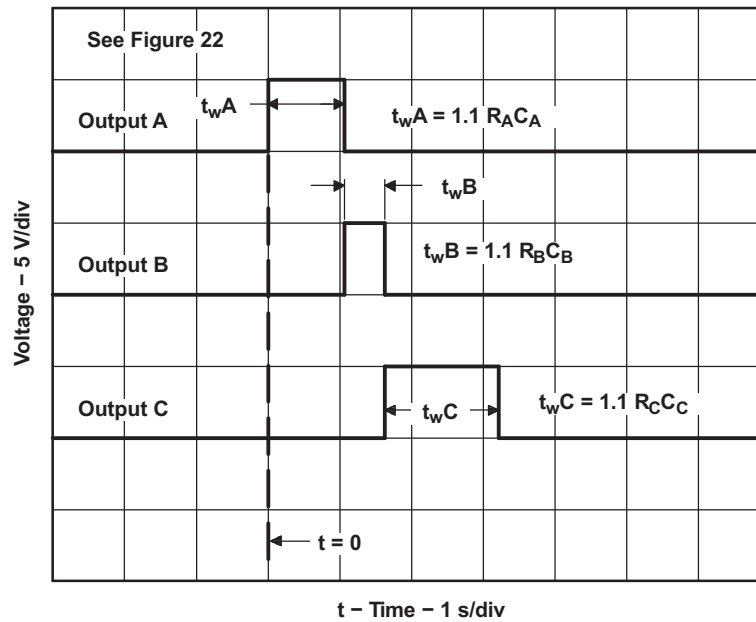
The sequential timer application chains together multiple monostable timers. The joining components are the 33-k $\Omega$  resistors and 0.001- $\mu$ F capacitors. The output high to low edge passes a 10- $\mu$ s start pulse to the next monostable.

### 9.2.4.2 Detailed Design Procedure

The timing resistors and capacitors can be chosen using this formula:  $t_w = 1.1 \times R \times C$ .

## Typical Applications (continued)

### 9.2.4.3 Application Curve



**Figure 19. Sequential Timer Waveforms**

## 10 Power Supply Recommendations

The TLC555 requires a voltage supply within 2 V to 15 V. Adequate power supply bypassing is necessary to protect associated circuitry. Minimum recommended is 0.1- $\mu$ F ceramic in parallel with 1- $\mu$ F electrolytic. Place the bypass capacitors as close as possible to the TLC555 and minimize the trace length.

## 11 Layout

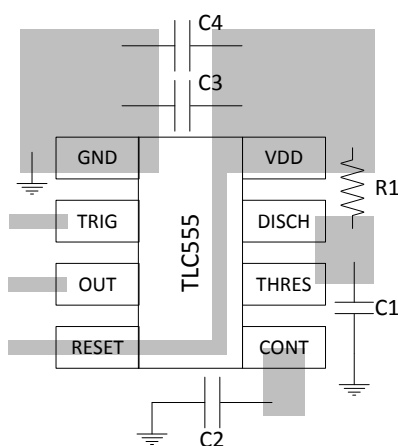
### 11.1 Layout Guidelines

Standard PCB rules apply to routing the TLC555. The 0.1- $\mu$ F ceramic capacitor in parallel with a 1- $\mu$ F electrolytic capacitor must be as close as possible to the TLC555. The capacitor used for the time delay must also be placed as close to the discharge pin. A ground plane on the bottom layer can be used to provide better noise immunity and signal integrity.

Figure 20 is the basic layout for various applications.

- C1—based on time delay calculations
- C2—0.01- $\mu$ F bypass capacitor for control voltage pin
- C3—0.1- $\mu$ F bypass ceramic capacitor
- C4—1- $\mu$ F electrolytic bypass capacitor
- R1—based on time-delay calculations

### 11.2 Layout Example



**Figure 20. Layout Example**

## 12 Device and Documentation Support

### 12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

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### 12.3 Trademarks

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### 12.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLC555CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	<a href="#">Samples</a>
TLC555CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	<a href="#">Samples</a>
TLC555CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	<a href="#">Samples</a>
TLC555CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	TL555C	<a href="#">Samples</a>
TLC555CP	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	TLC555CP	<a href="#">Samples</a>
TLC555CPE4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	TLC555CP	<a href="#">Samples</a>
TLC555CPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	<a href="#">Samples</a>
TLC555CPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	<a href="#">Samples</a>
TLC555CPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	<a href="#">Samples</a>
TLC555CPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	P555	<a href="#">Samples</a>
TLC555ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	<a href="#">Samples</a>
TLC555IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	<a href="#">Samples</a>
TLC555IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	<a href="#">Samples</a>
TLC555IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL555I	<a href="#">Samples</a>
TLC555IP	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	TLC555IP	<a href="#">Samples</a>
TLC555IPE4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	TLC555IP	<a href="#">Samples</a>
TLC555QDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL555Q	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLC555QDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		TL555Q	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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## OTHER QUALIFIED VERSIONS OF TLC555 :

- Automotive: [TLC555-Q1](#)

- Military: [TLC555M](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC555CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555CPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC555IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555QDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC555QDRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1



## TAPE AND REEL BOX DIMENSIONS

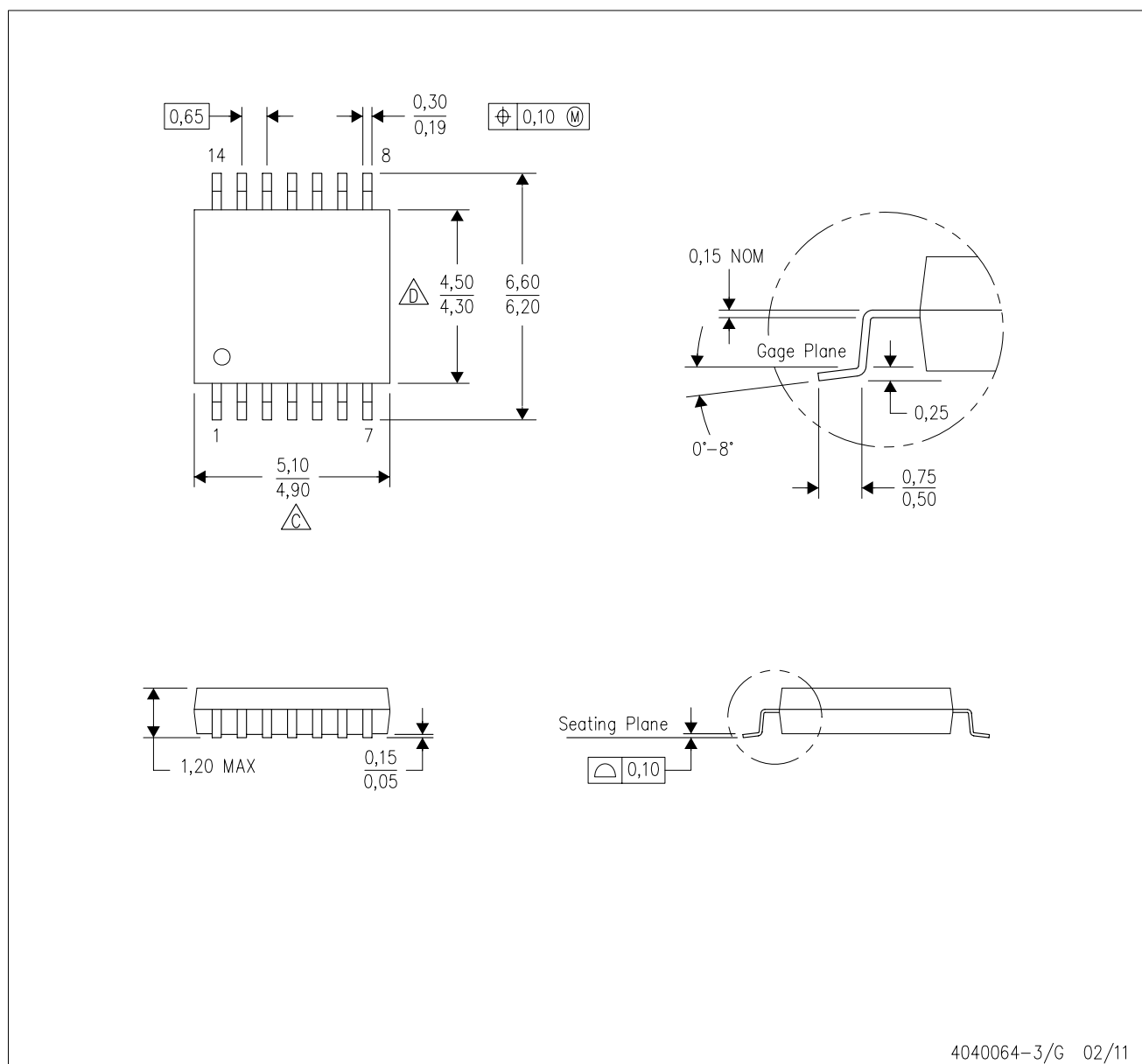


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC555CDR	SOIC	D	8	2500	340.5	338.1	20.6
TLC555CPWR	TSSOP	PW	14	2000	367.0	367.0	35.0
TLC555IDR	SOIC	D	8	2500	340.5	338.1	20.6
TLC555QDR	SOIC	D	8	2500	367.0	367.0	38.0
TLC555QDRG4	SOIC	D	8	2500	367.0	367.0	38.0

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

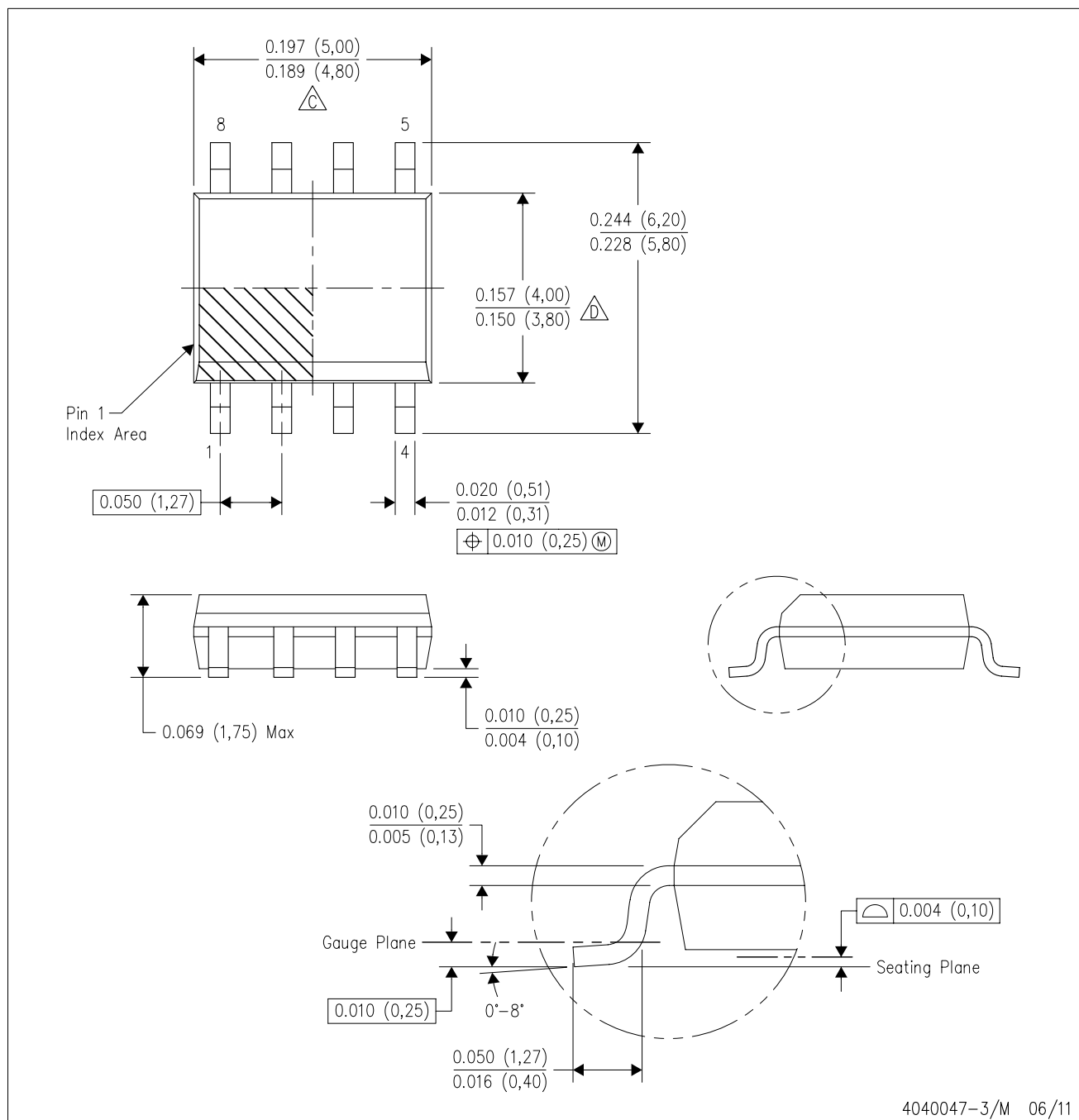
PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

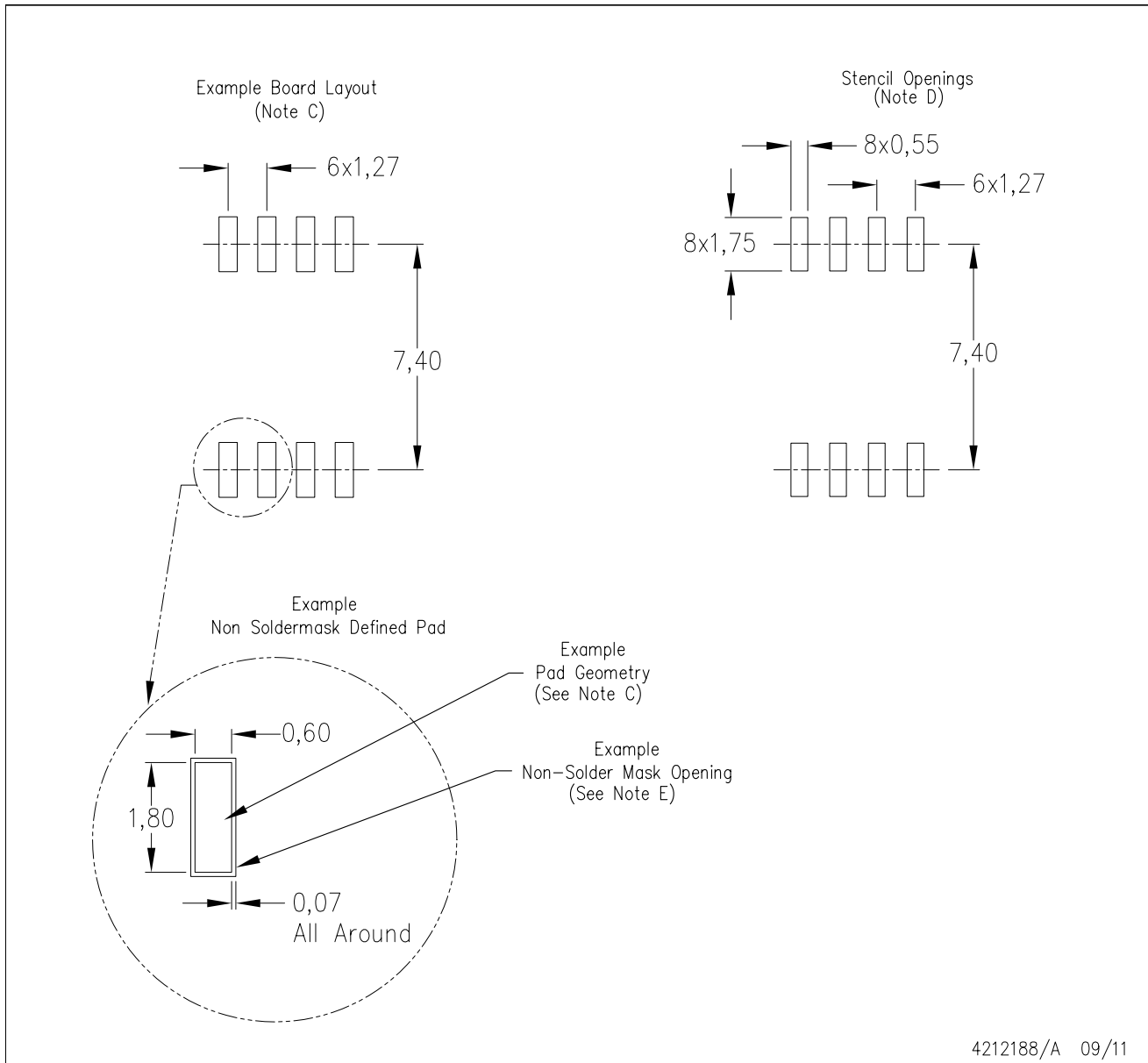


4040063/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## PS (R-PDSO-G8)

## PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.



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